

# HN58C256A Series

# HN58C257A Series

256k EEPROM (32-kword × 8-bit)  
Ready/Busy and RES function (HN58C257A)

# HITACHI

ADE-203-410D (Z)  
Rev. 4.0  
Oct. 24, 1997

## Description

The Hitachi HN58C256A and HN58C257A are electrically erasable and programmable ROMs organized as 32768-word × 8-bit. They have realized high speed low power consumption and high reliability by employing advanced MNOS memory technology and CMOS process and circuitry technology. They also have a 64-byte page programming function to make their write operations faster.

## Features

- Single 5 V supply: 5 V ±10%
- Access time: 85 ns/100 ns (max)
- Power dissipation
  - Active: 20 mW/MHz, (typ)
  - Standby: 110 μW (max)
- On-chip latches: address, data,  $\overline{CE}$ ,  $\overline{OE}$ ,  $\overline{WE}$
- Automatic byte write: 10 ms max
- Automatic page write (64 bytes): 10 ms max
- Ready/Busy (only the HN58C257A series)
- $\overline{Data}$  polling and Toggle bit
- Data protection circuit on power on/off
- Conforms to JEDEC byte-wide standard
- Reliable CMOS with MNOS cell technology
- 10<sup>5</sup> erase/write cycles (in page mode)
- 10 years data retention
- Software data protection
- Write protection by  $\overline{RES}$  pin (only the HN58C257A series)
- Industrial versions (Temperatur range: – 20 to 85°C and – 40 to 85°C) are also available.

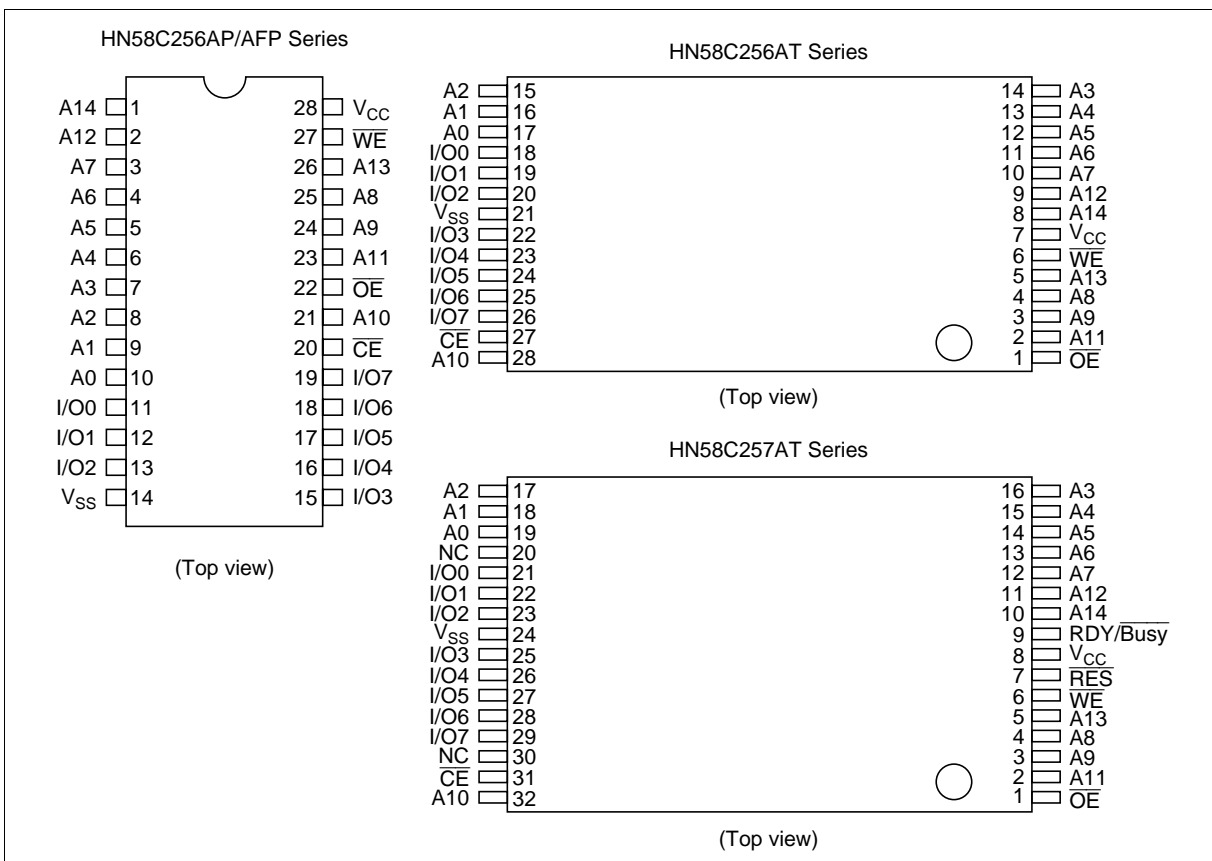


## HN58C256A Series, HN58C257A Series

### Ordering Information

Type No.	Access time	Package
HN58C256AP-85	85 ns	600 mil 28-pin plastic DIP (DP-28)
HN58C256AP-10	100 ns	
HN58C256AFP-85	85 ns	400 mil 28-pin plastic SOP (FP-28D)
HN58C256AFP-10	100 ns	
HN58C256AT-85	85 ns	28-pin plastic TSOP (TFP-28DB)
HN58C256AT-10	100 ns	
HN58C257AT-85	85 ns	8 × 14 mm <sup>2</sup> 32-pin plastic TSOP (TFP-32DA)
HN58C257AT-10	100 ns	

### Pin Arrangement



## HN58C256A Series, HN58C257A Series

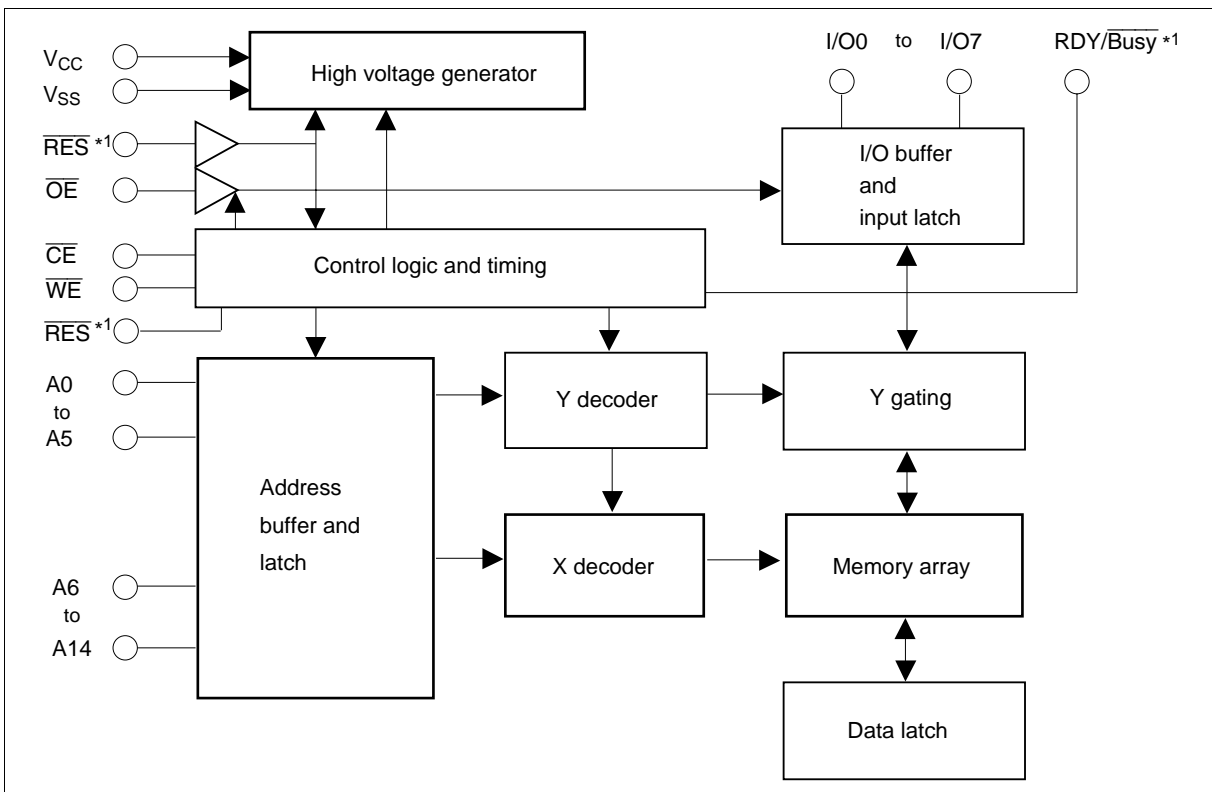
### Pin Description

Pin name	Function
A0 to A14	Address input
I/O0 to I/O7	Data input/output
$\overline{OE}$	Output enable
$\overline{CE}$	Chip enable
$\overline{WE}$	Write enable
$V_{CC}$	Power supply
$V_{SS}$	Ground
$RDY/\overline{Busy}^{*1}$	Ready busy
$\overline{RES}^{*1}$	Reset
NC	No connection

Note: 1. This function is supported by only the HN58C257A series.

### Block Diagram

Note: This function is supported by only the HN58C257A series.



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### Operation Table

Operation	$\overline{CE}$	$\overline{OE}$	$\overline{WE}$	$\overline{RES}^{*3}$	$\overline{RDY/Busy}^{*3}$	I/O
Read	$V_{IL}$	$V_{IL}$	$V_{IH}$	$V_H^{*1}$	High-Z	Dout
Standby	$V_{IH}$	$\times^{*2}$	$\times$	$\times$	High-Z	High-Z
Write	$V_{IL}$	$V_{IH}$	$V_{IL}$	$V_H$	High-Z to $V_{OL}$	Din
Deselect	$V_{IL}$	$V_{IH}$	$V_{IH}$	$V_H$	High-Z	High-Z
Write inhibit	$\times$	$\times$	$V_{IH}$	$\times$	—	—
	$\times$	$V_{IL}$	$\times$	$\times$	—	—
Data polling	$V_{IL}$	$V_{IL}$	$V_{IH}$	$V_H$	$V_{OL}$	Dout (I/O7)
Program reset	$\times$	$\times$	$\times$	$V_{IL}$	High-Z	High-Z

- Notes: 1. Refer to the recommended DC operating condition.  
 2.  $\times$  : Don't care  
 3. This function is supported by only the HN58C257A series.

### Absolute Maximum Ratings

Parameter	Symbol	Value	Unit
Power supply voltage relative to $V_{SS}$	$V_{CC}$	-0.6 to +7.0	V
Input voltage relative to $V_{SS}$	$V_{in}$	-0.5 <sup>*1</sup> to +7.0 <sup>*3</sup>	V
Operating temperature range <sup>*2</sup>	$T_{opr}$	0 to +70	°C
Storage temperature range	$T_{stg}$	-55 to +125	°C

- Notes: 1.  $V_{in\ min} = -3.0\ V$  for pulse width  $\leq 50\ ns$   
 2. Including electrical characteristics and data retention  
 3. Should not exceed  $V_{CC} + 1\ V$ .

## HN58C256A Series, HN58C257A Series

### Recommended DC Operating Conditions

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	$V_{CC}$	4.5	5.0	5.5	V
	$V_{SS}$	0	0	0	V
Input voltage	$V_{IL}$	-0.3 <sup>*1</sup>	—	0.8	V
	$V_{IH}$	2.2	—	$V_{CC} + 0.3$ <sup>*2</sup>	V
	$V_H$ <sup>*3</sup>	$V_{CC} - 0.5$	—	$V_{CC} + 1.0$	V
Operating temperature	Topr	0	—	70	°C

- Notes: 1.  $V_{IL}$  min: -1.0 V for pulse width  $\leq$  50 ns.  
 2.  $V_{IH}$  max:  $V_{CC} + 1.0$  V for pulse width  $\leq$  50 ns.  
 3. This function is supported by only the HN58C257A series.

### DC Characteristics (Ta = 0 to +70°C, $V_{CC} = 5.0$ V $\pm$ 10%)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input leakage current	$I_{LI}$	—	—	2 <sup>*1</sup>	$\mu$ A	$V_{CC} = 5.5$ V, $V_{in} = 5.5$ V
Output leakage current	$I_{LO}$	—	—	2	$\mu$ A	$V_{CC} = 5.5$ V, $V_{out} = 5.5/0.4$ V
Standby $V_{CC}$ current	$I_{CC1}$	—	—	20	$\mu$ A	$\overline{CE} = V_{CC}$
	$I_{CC2}$	—	—	1	mA	$\overline{CE} = V_{IH}$
Operating $V_{CC}$ current	$I_{CC3}$	—	—	12	mA	$I_{out} = 0$ mA, Duty = 100%, Cycle = 1 $\mu$ s at $V_{CC} = 5.5$ V
		—	—	30	mA	$I_{out} = 0$ mA, Duty = 100%, Cycle = 85 ns at $V_{CC} = 5.5$ V
Output low voltage	$V_{OL}$	—	—	0.4	V	$I_{OL} = 2.1$ mA
Output high voltage	$V_{OH}$	2.4	—	—	V	$I_{OH} = -400$ $\mu$ A

Note: 1.  $I_{LI}$  on RES = 100  $\mu$ A max (only the HN58C257A series)

### Capacitance (Ta = +25°C, f = 1 MHz)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Input capacitance <sup>*1</sup>	Cin	—	—	6	pF	$V_{in} = 0$ V
Output capacitance <sup>*1</sup>	Cout	—	—	12	pF	$V_{out} = 0$ V

Note: 1. This parameter is periodically sampled and not 100% tested.

## HN58C256A Series, HN58C257A Series

AC Characteristics (Ta = 0 to +70°C, V<sub>CC</sub> = 5 V±10%)

### Test Conditions

- Input pulse levels: 0.4 V to 3.0 V  
0 V to V<sub>CC</sub> ( $\overline{\text{RES}}$  pin\*2)
- Input rise and fall time: ≤ 5 ns
- Input timing reference levels: 0.8, 2.0 V
- Output load: 1TTL Gate +100 pF
- Output reference levels: 1.5 V, 1.5 V

### Read Cycle

Parameter	Symbol	HN58C256A/HN58C257A				Unit	Test conditions
		-85		-10			
		Min	Max	Min	Max		
Address to output delay	t <sub>ACC</sub>	—	85	—	100	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}$ , $\overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{CE}}$ to output delay	t <sub>CE</sub>	—	85	—	100	ns	$\overline{\text{OE}} = V_{\text{IL}}$ , $\overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{OE}}$ to output delay	t <sub>OE</sub>	10	40	10	50	ns	$\overline{\text{CE}} = V_{\text{IL}}$ , $\overline{\text{WE}} = V_{\text{IH}}$
Address to output hold	t <sub>OH</sub>	0	—	0	—	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}$ , $\overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{OE}}$ ( $\overline{\text{CE}}$ ) high to output float*1	t <sub>DF</sub>	0	40	0	40	ns	$\overline{\text{CE}} = V_{\text{IL}}$ , $\overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{RES}}$ low to output float*1,2	t <sub>DFR</sub>	0	350	0	350	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}$ , $\overline{\text{WE}} = V_{\text{IH}}$
$\overline{\text{RES}}$ to output delay*2	t <sub>RR</sub>	0	450	0	450	ns	$\overline{\text{CE}} = \overline{\text{OE}} = V_{\text{IL}}$ , $\overline{\text{WE}} = V_{\text{IH}}$

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### Write Cycle

Parameter	Symbol	Min <sup>*3</sup>	Typ	Max	Unit	Test conditions
Address setup time	$t_{AS}$	0	—	—	ns	
Address hold time	$t_{AH}$	50	—	—	ns	
$\overline{CE}$ to write setup time ( $\overline{WE}$ controlled)	$t_{CS}$	0	—	—	ns	
$\overline{CE}$ hold time ( $\overline{WE}$ controlled)	$t_{CH}$	0	—	—	ns	
$\overline{WE}$ to write setup time ( $\overline{CE}$ controlled)	$t_{WS}$	0	—	—	ns	
$\overline{WE}$ hold time ( $\overline{CE}$ controlled)	$t_{WH}$	0	—	—	ns	
$\overline{OE}$ to write setup time	$t_{OES}$	0	—	—	ns	
$\overline{OE}$ hold time	$t_{OEH}$	0	—	—	ns	
Data setup time	$t_{DS}$	50	—	—	ns	
Data hold time	$t_{DH}$	0	—	—	ns	
$\overline{WE}$ pulse width ( $\overline{WE}$ controlled)	$t_{WP}$	100	—	—	ns	
$\overline{CE}$ pulse width ( $\overline{CE}$ controlled)	$t_{CW}$	100	—	—	ns	
Data latch time	$t_{DL}$	50	—	—	ns	
Byte load cycle	$t_{BLC}$	0.2	—	30	$\mu$ s	
Byte load window	$t_{BL}$	100	—	—	$\mu$ s	
Write cycle time	$t_{WC}$	—	—	$10^{*4}$	ms	
Time to device busy	$t_{DB}$	120	—	—	ns	
Write start time	$t_{DW}$	$0^{*5}$	—	—	ns	
Reset protect time <sup>*2</sup>	$t_{RP}$	100	—	—	$\mu$ s	
Reset high time <sup>*2,6</sup>	$t_{RES}$	1	—	—	$\mu$ s	

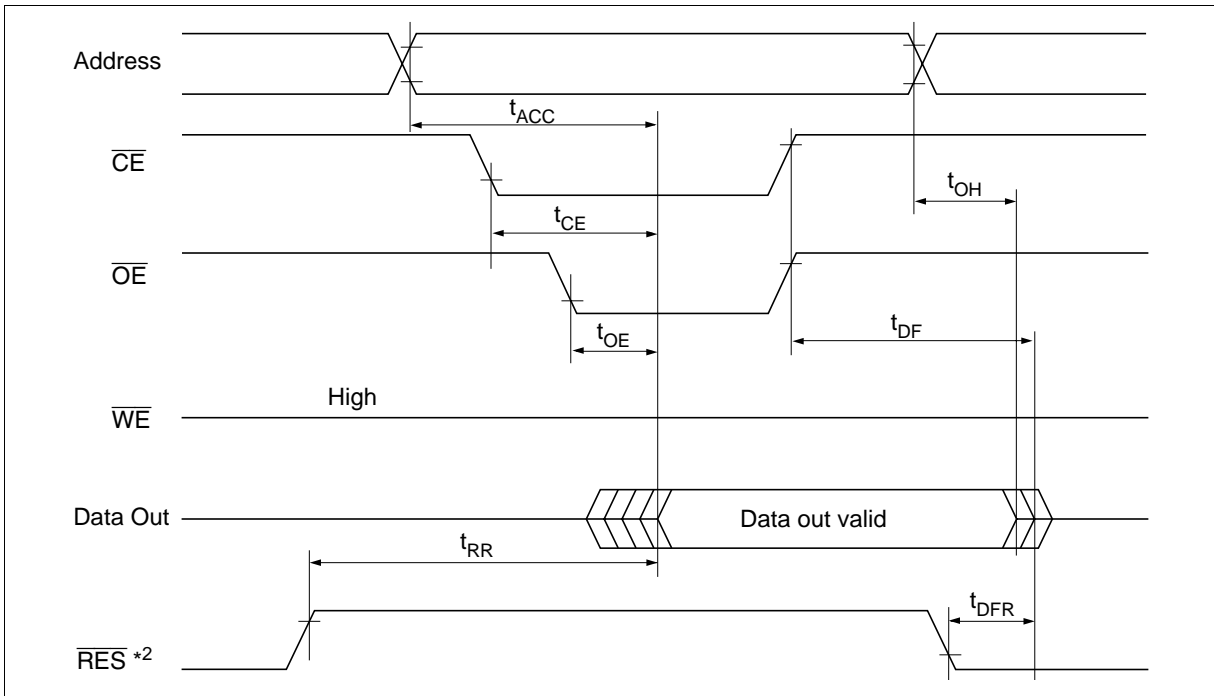
- Notes:
1.  $t_{DF}$  and  $t_{DFR}$  are defined as the time at which the outputs achieve the open circuit conditions and are no longer driven.
  2. This function is supported by only the HN58C257A series.
  3. Use this device in longer cycle than this value.
  4.  $t_{WC}$  must be longer than this value unless polling techniques or  $\overline{RDY}/\overline{Busy}$  (only the HN58C257A series) are used. This device automatically completes the internal write operation within this value.
  5. Next read or write operation can be initiated after  $t_{DW}$  if polling techniques or  $\overline{RDY}/\overline{Busy}$  (only the HN58C257A series) are used.
  6. This parameter is sampled and not 100% tested.
  7. A6 through A14 are page address and these addresses are latched at the first falling edge of  $\overline{WE}$ .
  8. A6 through A14 are page address and these addresses are latched at the first falling edge of  $\overline{CE}$ .
  9. See AC read characteristics.

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## HN58C256A Series, HN58C257A Series

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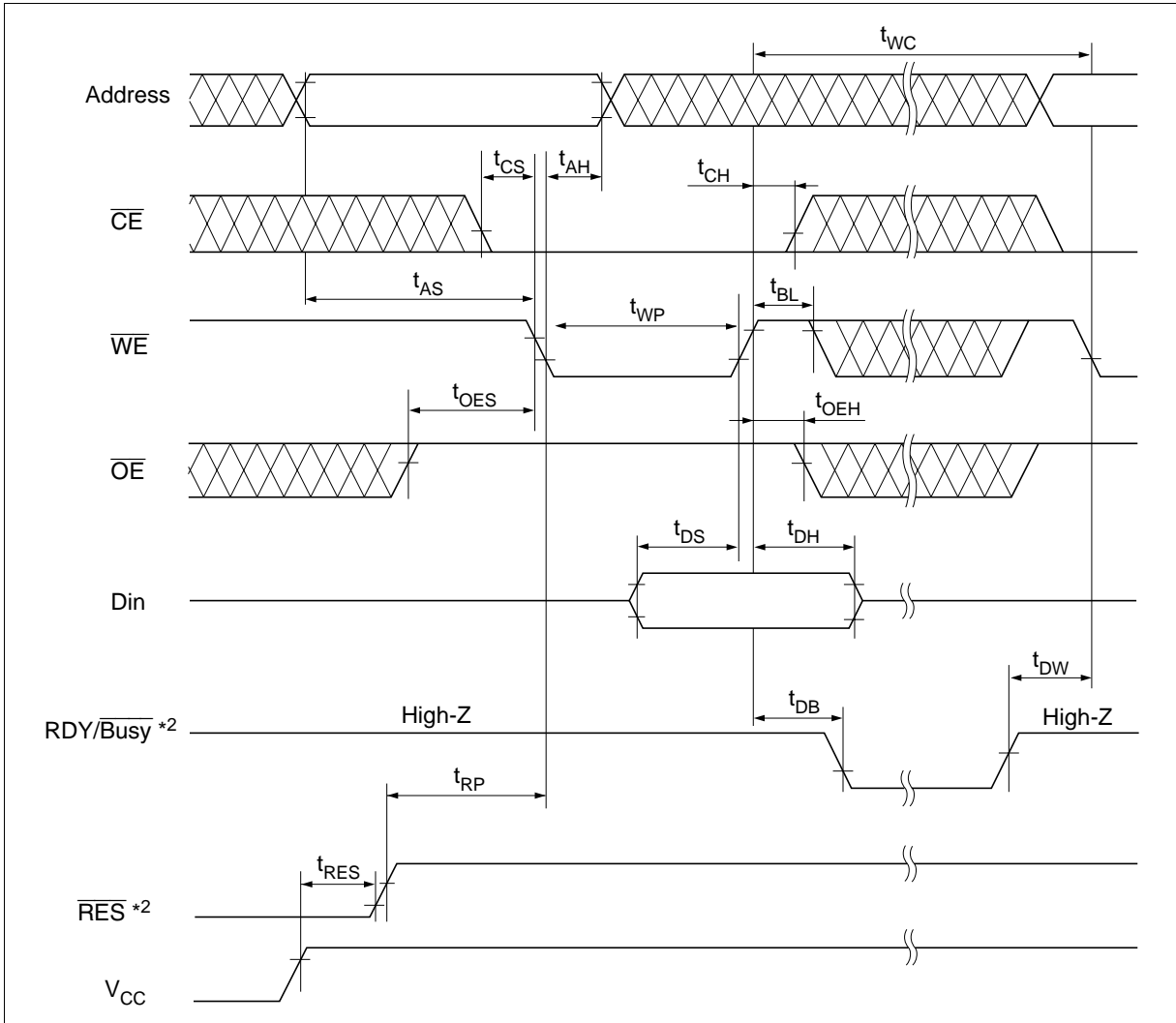
### Read Timing Waveform





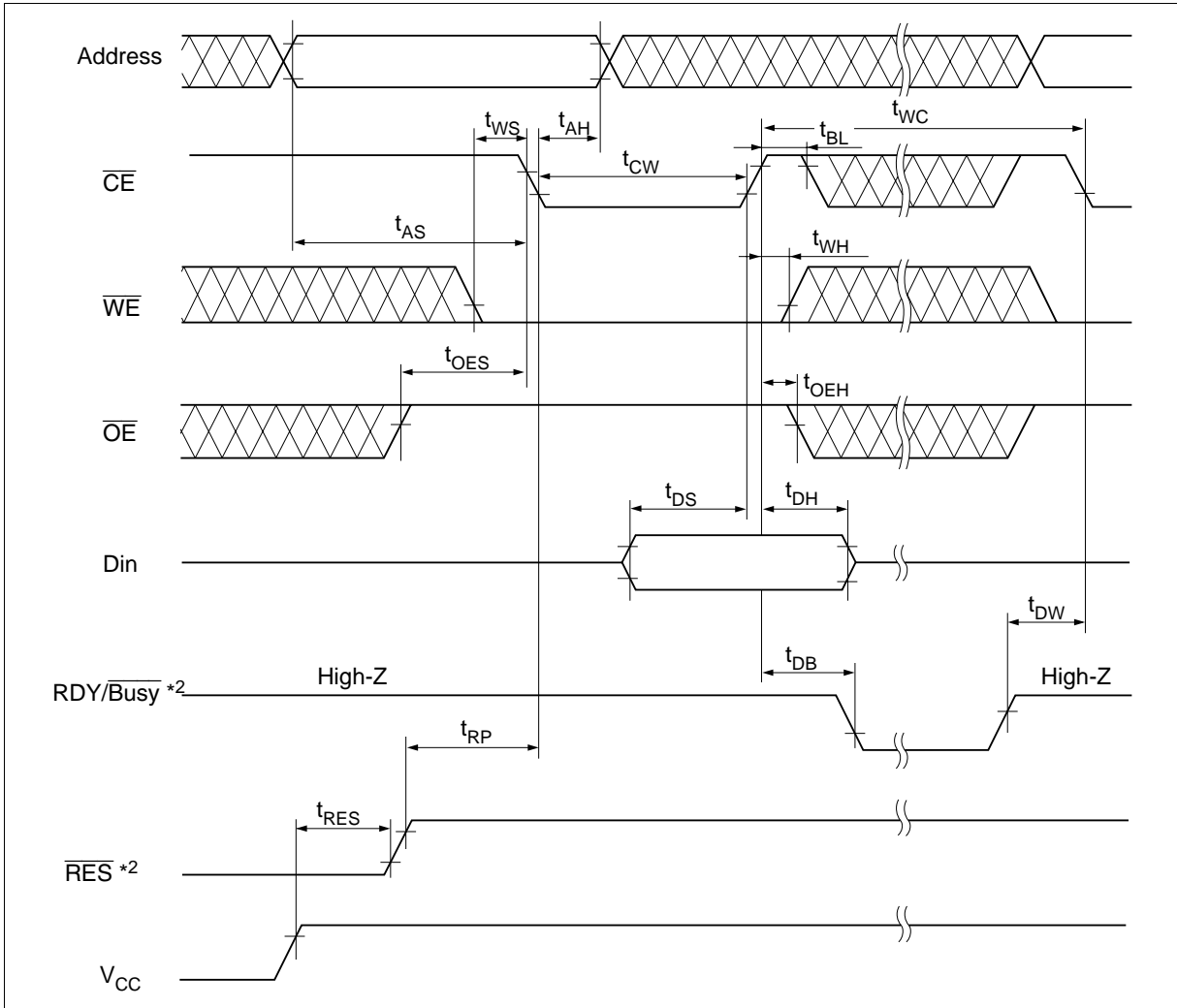
## HN58C256A Series, HN58C257A Series

**Byte Write Timing Waveform (1) ( $\overline{WE}$  Controlled)**



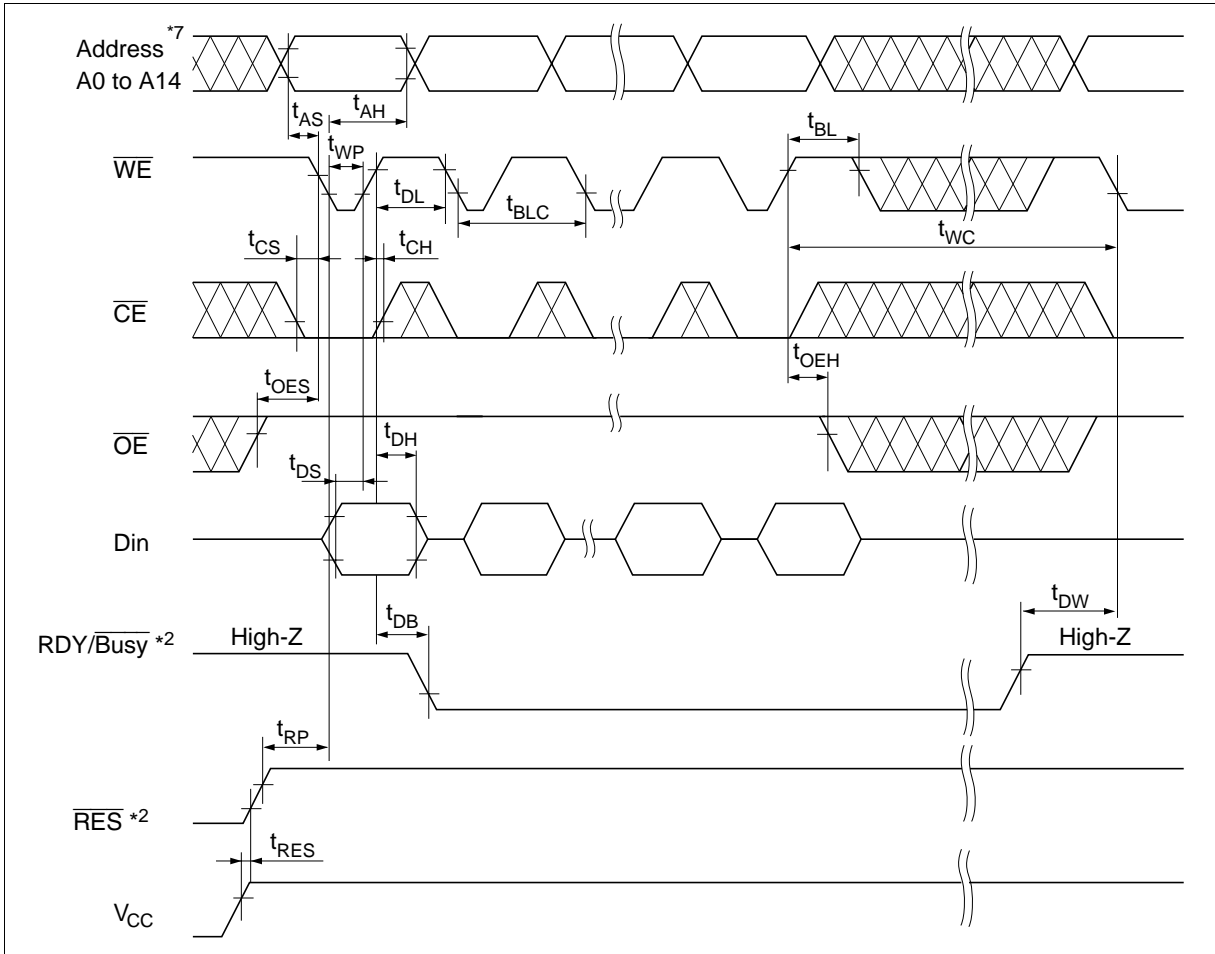
## HN58C256A Series, HN58C257A Series

Byte Write Timing Waveform (2) ( $\overline{\text{CE}}$  Controlled)



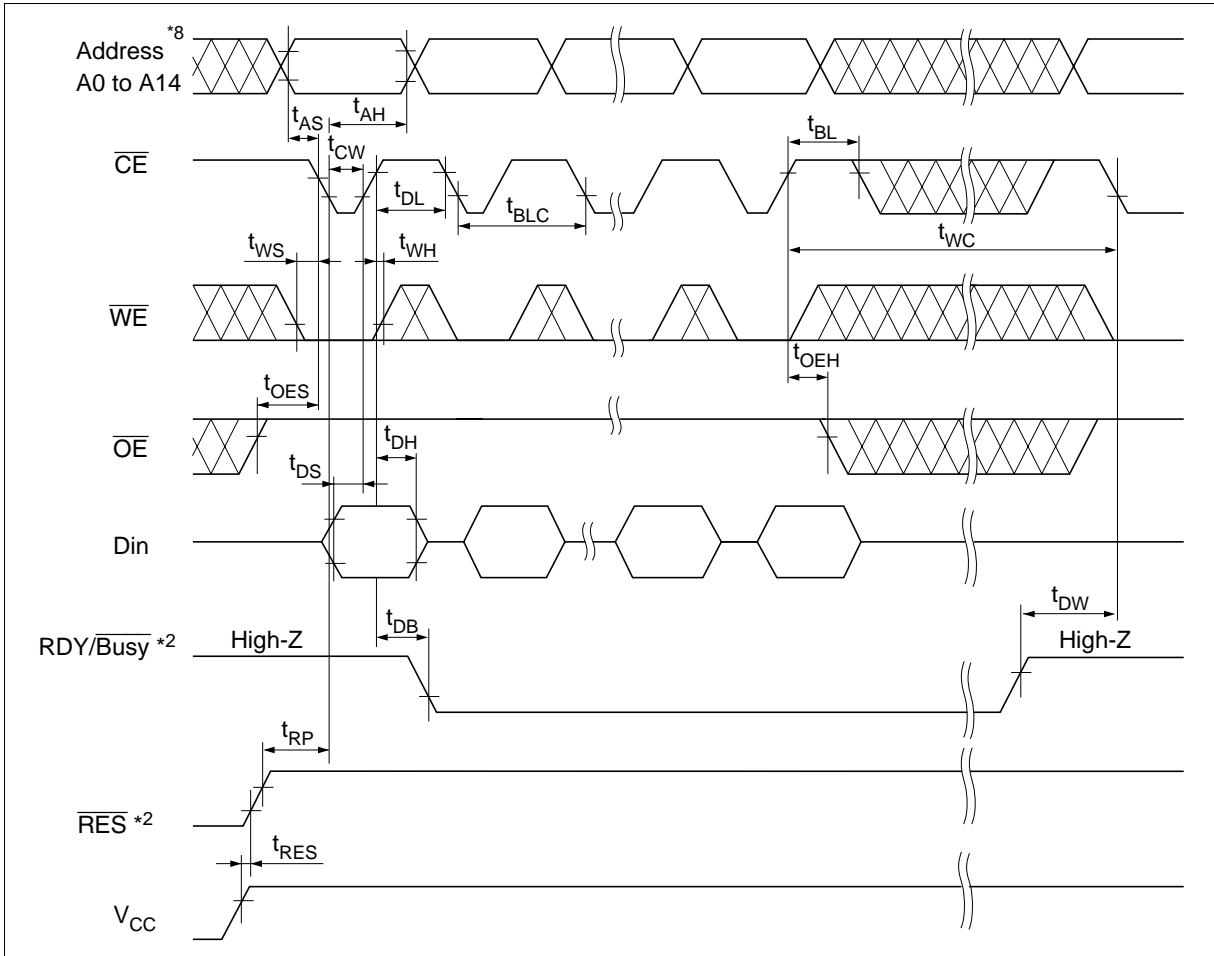
## HN58C256A Series, HN58C257A Series

**Page Write Timing Waveform (1) ( $\overline{\text{WE}}$  Controlled)**



# HN58C256A Series, HN58C257A Series

Page Write Timing Waveform (2) ( $\overline{\text{CE}}$  Controlled)

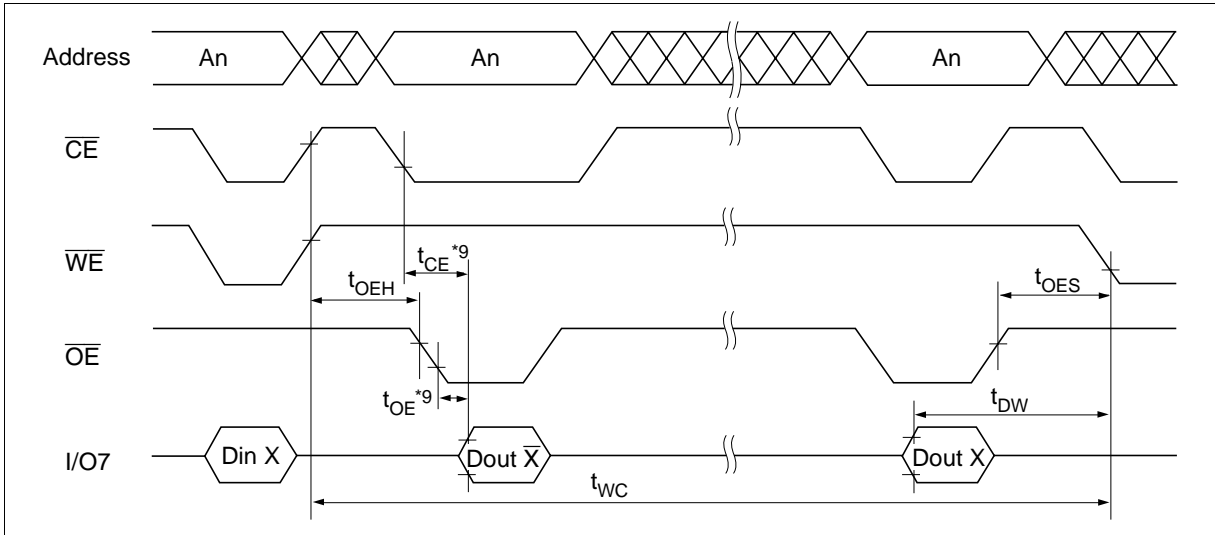


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### Data Polling Timing Waveform



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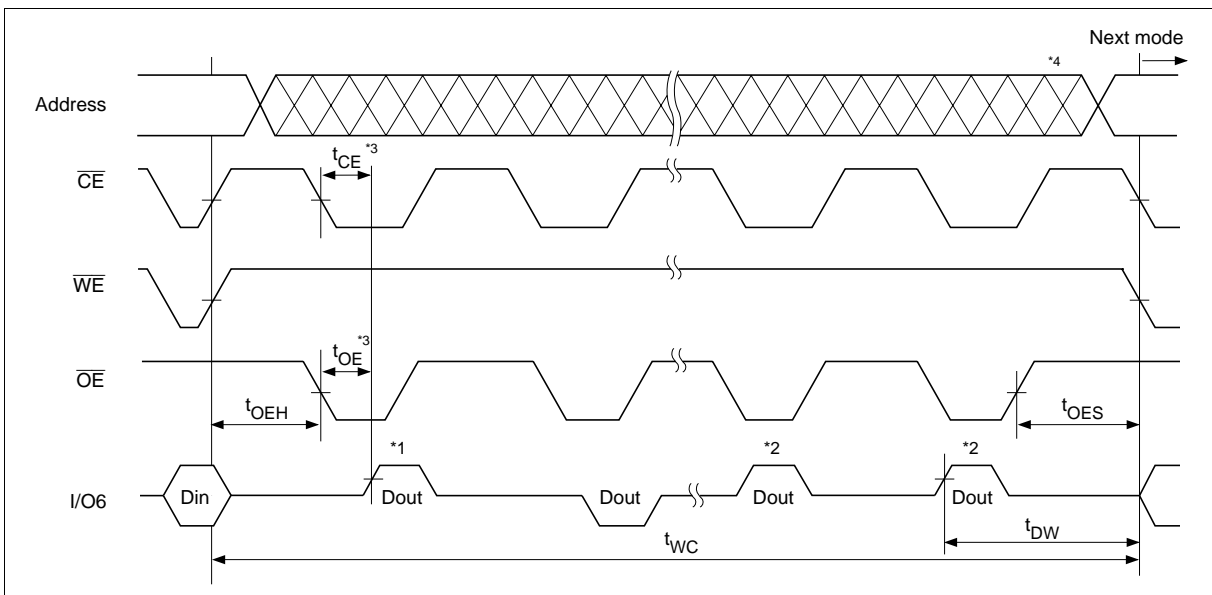
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### Toggle bit

This device provide another function to determine the internal programming cycle. If the EEPROM is set to read mode during the internal programming cycle, I/O6 will charge from "1" to "0" (toggling) for each read. When the internal programming cycle is finished, toggling of I/O6 will stop and the device can be accessible for next read or program.

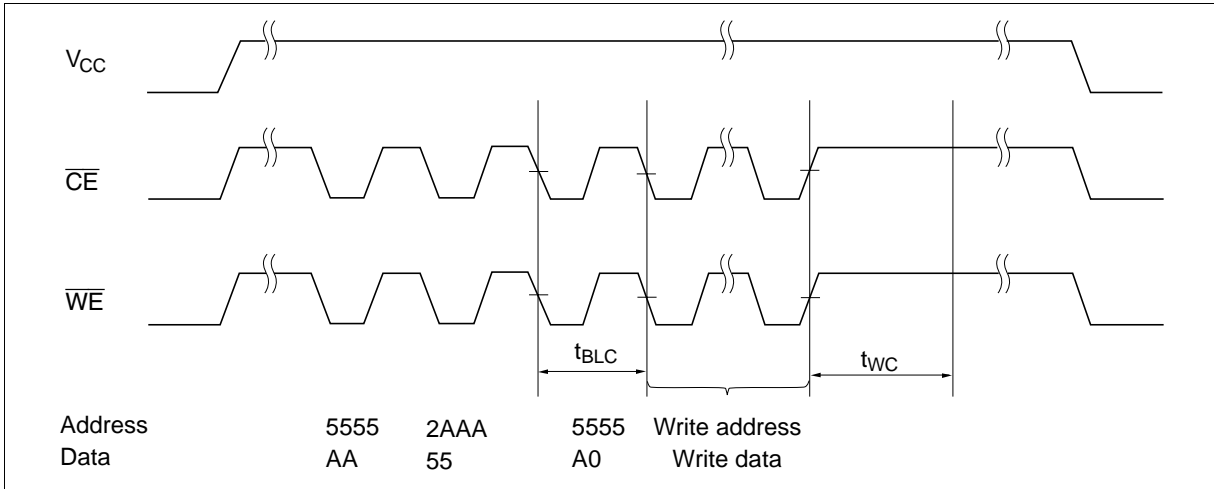
### Toggle bit Waveform

- Notes:
1. I/O6 beginning state is "1".
  2. I/O6 ending state will vary.
  3. See AC read characteristics.
  4. Any address location can be used, but the address must be fixed.

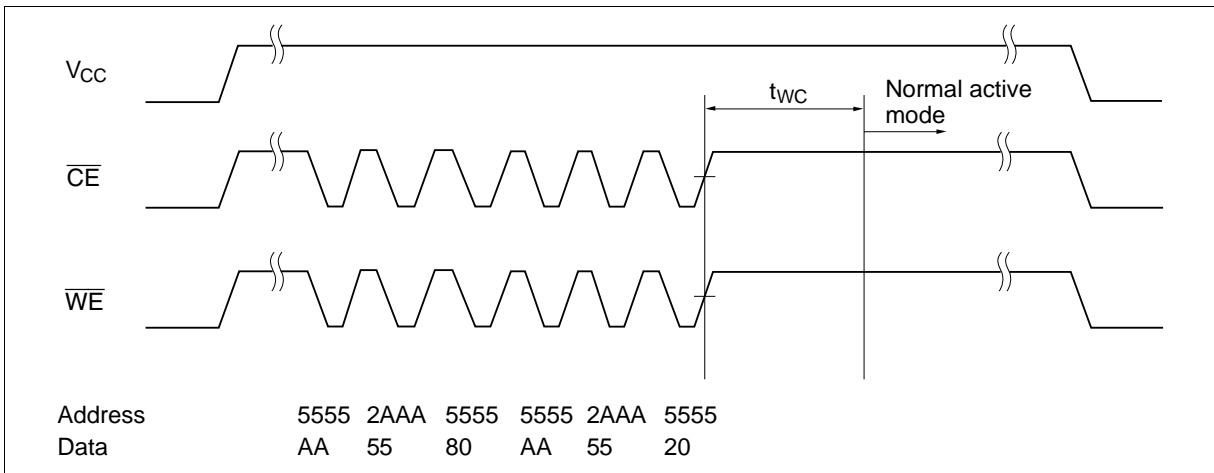


## HN58C256A Series, HN58C257A Series

**Software Data Protection Timing Waveform (1) (in protection mode)**



**Software Data Protection Timing Waveform (2) (in non-protection mode)**



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## HN58C256A Series, HN58C257A Series

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### Functional Description

#### Automatic Page Write

Page-mode write feature allows 1 to 64 bytes of data to be written into the EEPROM in a single write cycle. Following the initial byte cycle, an additional 1 to 63 bytes can be written in the same manner. Each additional byte load cycle must be started within 30  $\mu$ s from the preceding falling edge of  $\overline{WE}$  or  $\overline{CE}$ . When  $\overline{CE}$  or  $\overline{WE}$  is high for 100  $\mu$ s after data input, the EEPROM enters write mode automatically and the input data are written into the EEPROM.

#### $\overline{Data}$ Polling

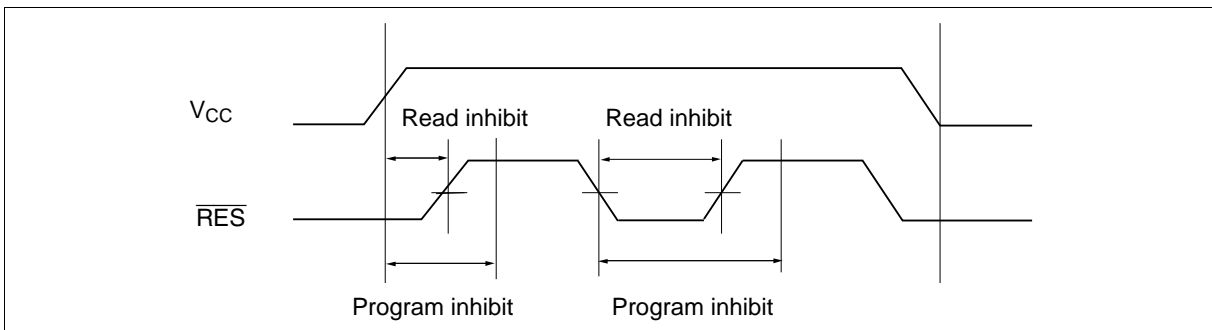
$\overline{Data}$  polling indicates the status that the EEPROM is in a write cycle or not. If EEPROM is set to read mode during a write cycle, an inversion of the last byte of data outputs from I/O7 to indicate that the EEPROM is performing a write operation.

#### $\overline{RDY/Busy}$ Signal (only the HN58C257A series)

$\overline{RDY/Busy}$  signal also allows status of the EEPROM to be determined. The  $\overline{RDY/Busy}$  signal has high impedance except in write cycle and is lowered to  $V_{OL}$  after the first write signal. At the end of a write cycle, the  $\overline{RDY/Busy}$  signal changes state to high impedance.

#### $\overline{RES}$ Signal (only the HN58C257A series)

When  $\overline{RES}$  is low, the EEPROM cannot be read or programmed. Therefore, data can be protected by keeping  $\overline{RES}$  low when  $V_{CC}$  is switched.  $\overline{RES}$  should be high during read and programming because it doesn't provide a latch function.





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## HN58C256A Series, HN58C257A Series

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### $\overline{\text{WE}}$ , $\overline{\text{CE}}$ Pin Operation

During a write cycle, addresses are latched by the falling edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ , and data is latched by the rising edge of  $\overline{\text{WE}}$  or  $\overline{\text{CE}}$ .

### Write/Erase Endurance and Data Retention Time

The endurance is  $10^5$  cycles in case of the page programming and  $10^4$  cycles in case of the byte programming (1% cumulative failure rate). The data retention time is more than 10 years when a device is page-programmed less than  $10^4$  cycles.

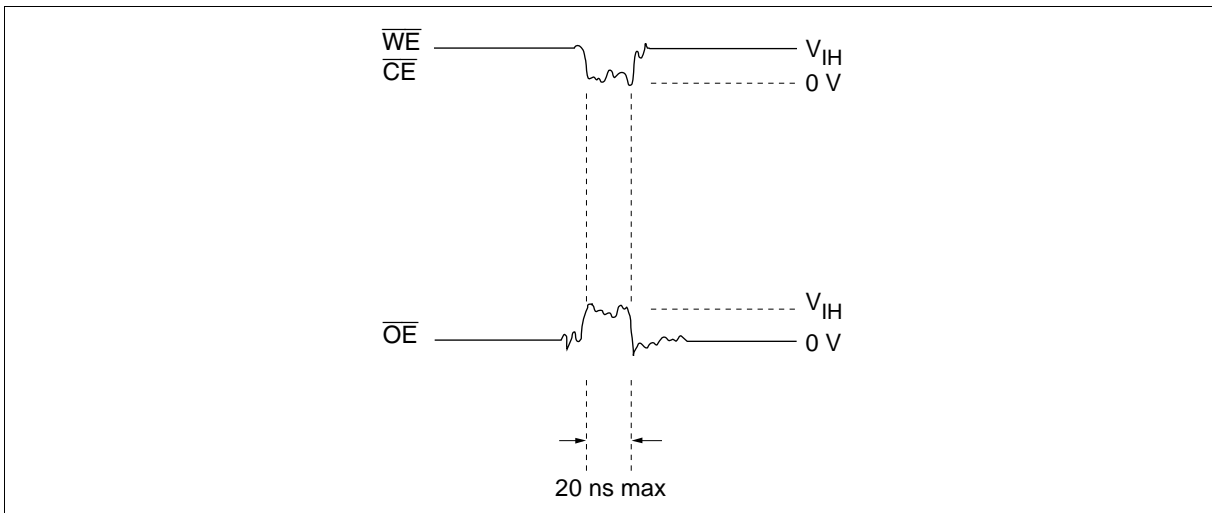
### Data Protection

#### 1. Data Protection against Noise on Control Pins ( $\overline{\text{CE}}$ , $\overline{\text{OE}}$ , $\overline{\text{WE}}$ ) during Operation

During readout or standby, noise on the control pins may act as a trigger and turn the EEPROM to programming mode by mistake.

To prevent this phenomenon, this device has a noise cancelation function that cuts noise if its width is 20 ns or less.

Be careful not to allow noise of a width of more than 20 ns on the control pins.



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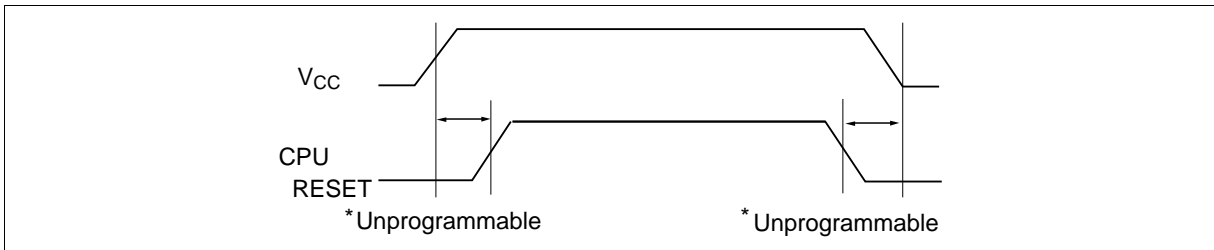
## HN58C256A Series, HN58C257A Series

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### 2. Data Protection at $V_{CC}$ On/Off

When  $V_{CC}$  is turned on or off, noise on the control pins generated by external circuits (CPU, etc) may act as a trigger and turn the EEPROM to program mode by mistake. To prevent this unintentional programming, the EEPROM must be kept in an unprogrammable state while the CPU is in an unstable state.

Note: The EEPROM should be kept in unprogrammable state during  $V_{CC}$  on/off by using CPU RESET signal.



#### (1) Protection by $\overline{CE}$ , $\overline{OE}$ , $\overline{WE}$

To realize the unprogrammable state, the input level of control pins must be held as shown in the table below.

$\overline{CE}$	$V_{CC}$	×	×
$\overline{OE}$	×	$V_{SS}$	×
$\overline{WE}$	×	×	$V_{CC}$

×: Don't care.

$V_{CC}$ : Pull-up to  $V_{CC}$  level.

$V_{SS}$ : Pull-down to  $V_{SS}$  level.

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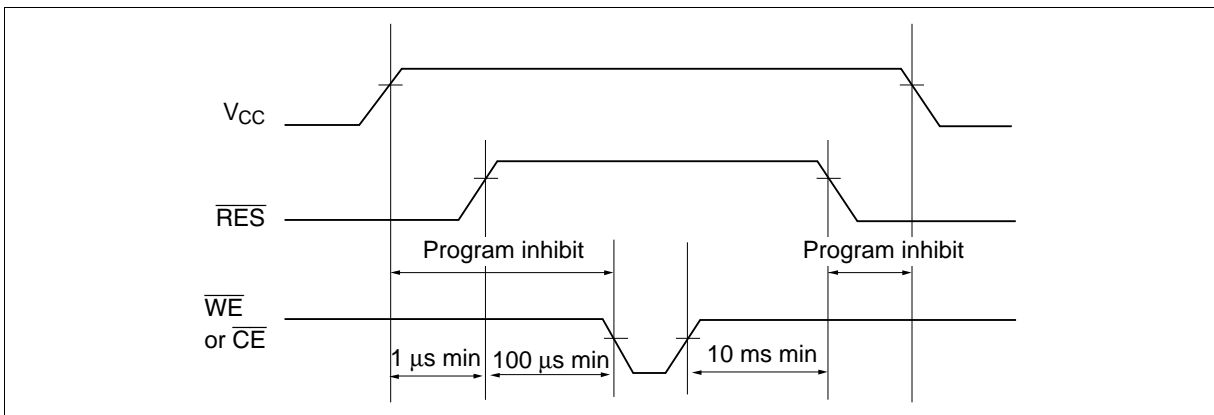
## HN58C256A Series, HN58C257A Series

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(2) Protection by  $\overline{\text{RES}}$  (only the HN58C257A series)

The unprogrammable state can be realized by that the CPU's reset signal inputs directly to the EEPROM's  $\overline{\text{RES}}$  pin.  $\overline{\text{RES}}$  should be kept  $V_{\text{SS}}$  level during  $V_{\text{CC}}$  on/off.

The EEPROM breaks off programming operation when  $\overline{\text{RES}}$  becomes low, programming operation doesn't finish correctly in case that  $\overline{\text{RES}}$  falls low during programming operation.  $\overline{\text{RES}}$  should be kept high for 10 ms after the last data input.



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## HN58C256A Series, HN58C257A Series

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### 3. Software data protection

To prevent unintentional programming, this device has the software data protection (SDP) mode. The SDP is enabled by inputting the following 3 bytes code and write data. SDP is not enabled if only the 3 bytes code is input. To program data in the SDP enable mode, 3 bytes code must be input before write data.

Address	Data
5555	AA
↓	↓
2AAA	55
↓	↓
5555	A0
↓	↓
Write address	Write data } Normal data input

The SDP mode is disabled by inputting the following 6 bytes code. Note that, if data is input in the SDP disable cycle, data can not be written.

Address	Data
5555	AA
↓	↓
2AAA	55
↓	↓
5555	80
↓	↓
5555	AA
↓	↓
2AAA	55
↓	↓
5555	20

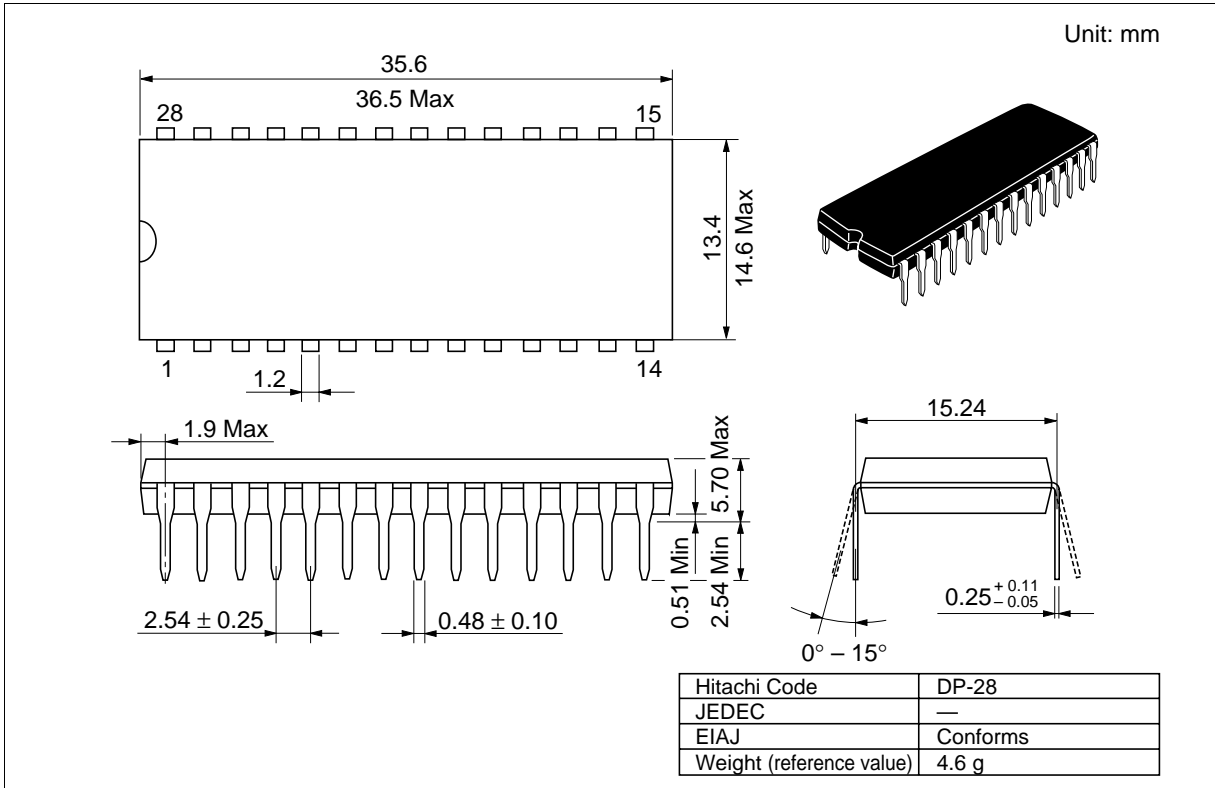
The software data protection is not enabled at the shipment.

Note: There are some differences between Hitachi's and other company's for enable/disable sequence of software data protection. If there are any questions, please contact with Hitachi sales offices.

## HN58C256A Series, HN58C257A Series

### Package Dimensions

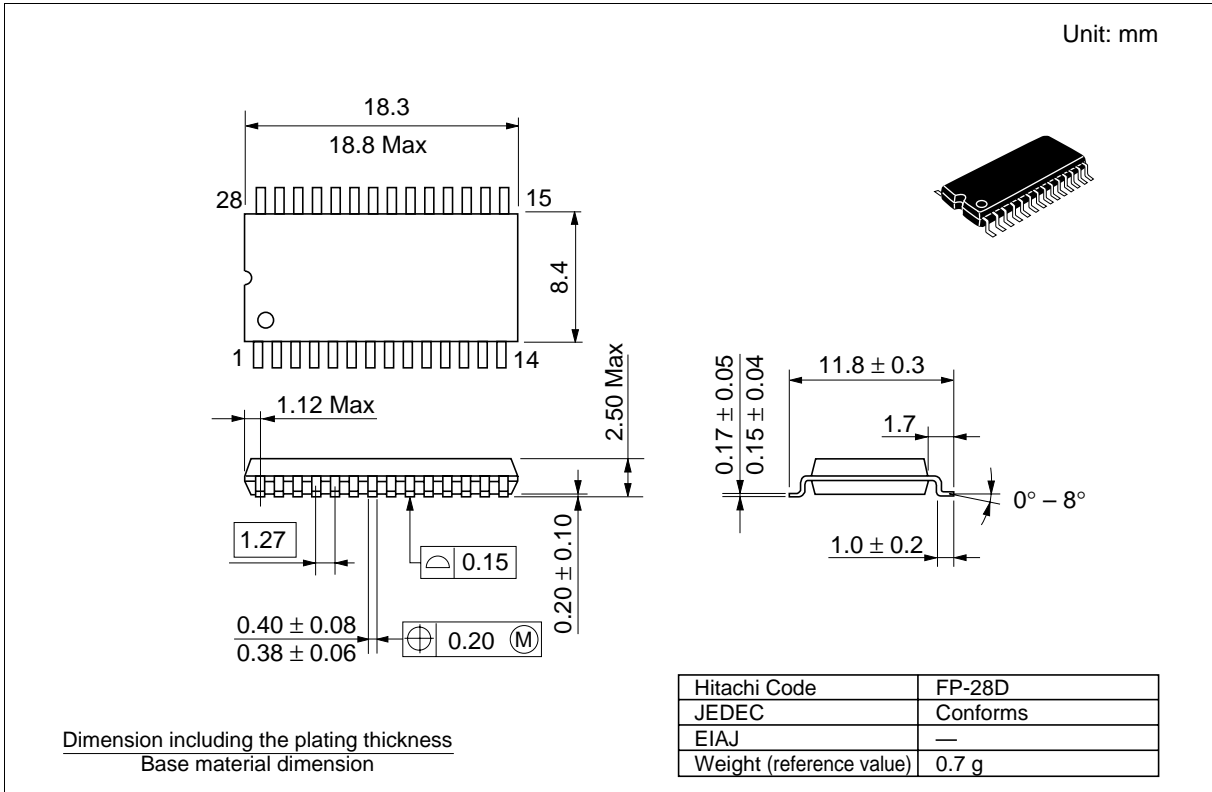
#### HN58C256AP Series (DP-28)



## HN58C256A Series, HN58C257A Series

### Package Dimensions (cont.)

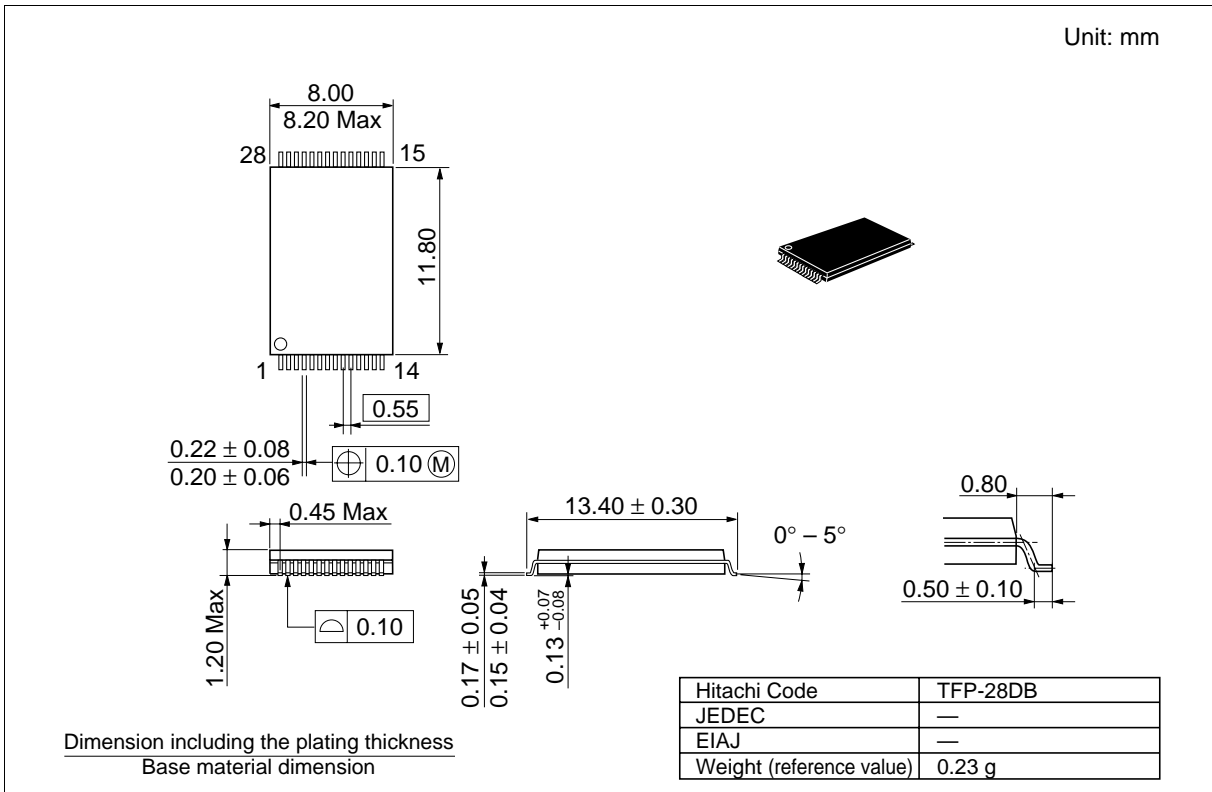
#### HN58C256AFP Series (FP-28D)



## HN58C256A Series, HN58C257A Series

### Package Dimensions (cont.)

#### HN58C256AT Series (TFP-28DB)







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## HN58C256A Series, HN58C257A Series

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# HITACHI

## Hitachi, Ltd.

Semiconductor & IC Div.  
Nippon Bldg., 2-6-2, Ohte-machi, Chiyoda-ku, Tokyo 100, Japan  
Tel: Tokyo (03) 3270-2111  
Fax: (03) 3270-5109

### For further information write to:

Hitachi America, Ltd.  
Semiconductor & IC Div.  
2000 Sierra Point Parkway  
Brisbane, CA. 94005-1835  
U S A  
Tel: 415-589-8300  
Fax: 415-583-4207

Hitachi Europe GmbH  
Electronic Components Group  
Continental Europe  
Dornacher Straße 3  
D-85622 Feldkirchen  
München  
Tel: 089-9 91 80-0  
Fax: 089-9 29 30 00

Hitachi Europe Ltd.  
Electronic Components Div.  
Northern Europe Headquarters  
Whitebrook Park  
Lower Cookham Road  
Maidenhead  
Berkshire SL6 8YA  
United Kingdom  
Tel: 0628-585000  
Fax: 0628-778322

Hitachi Asia Pte. Ltd.  
16 Collyer Quay #20-00  
Hitachi Tower  
Singapore 0104  
Tel: 535-2100  
Fax: 535-1533

Hitachi Asia (Hong Kong) Ltd.  
Unit 706, North Tower,  
World Finance Centre,  
Harbour City, Canton Road  
Tsim Sha Tsui, Kowloon  
Hong Kong  
Tel: 27359218  
Fax: 27306071